

BB170 VHF variable capacitance diode Rev. 1 — 25 March 2013

Product data sheet

1. Product profile

1.1 General description

The BB170 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

1.2 Features and benefits

- Excellent linearity
- Very small SMD plastic package
- $C_{d(28V)} = 2.6 \text{ pF}; C_{d(1V)} \text{ to } C_{d(28V)} \text{ ratio} = 15$
- Low series resistance

1.3 Applications

Voltage Controlled Oscillators (VCO)

2. Pinning information

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	
2	anode		$\overset{\#}{\vdash}$
			sym008

[1] The marking bar indicates the cathode.

3. Ordering information

Table 2.Ordering information

Type number	Package			
	Name	Description	Version	
BB170	SC-76	plastic surface-mounted package; 2 leads	SOD323	



4. Marking

Table 3.	Marking	
Type num	ber	Marking code
BB170		4H

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	30	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5.Characteristics

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

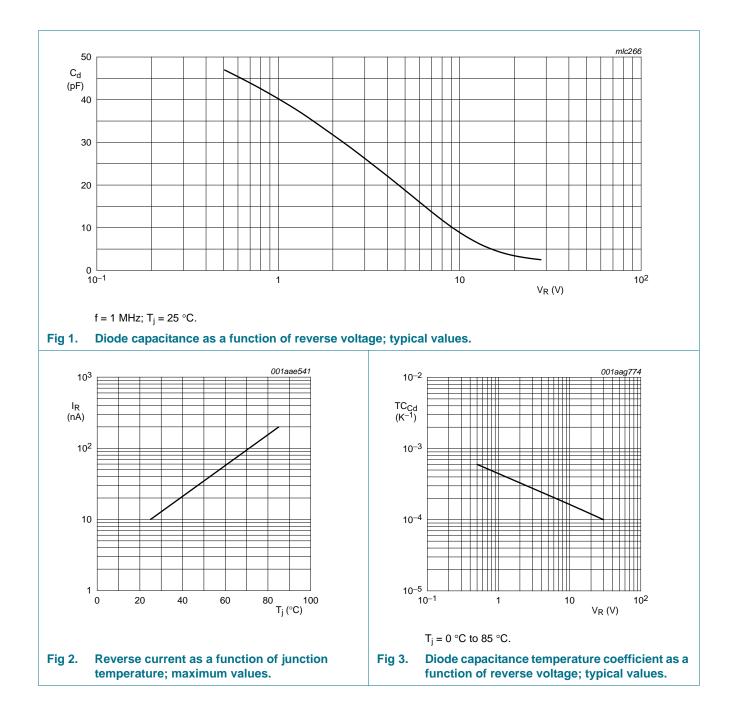
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
I _R	reverse current	V _R = 30 V	[1]	-	-	10	nA
		V _R = 30 V; T _j = 85 °C	[1]	-	-	200	nA
r _s	diode series resistance	$f = 100 \text{ MHz}; C_d = 12 \text{ pF}$		-	-	0.9	Ω
C _d	diode capacitance	f = 1 MHz	[2]				
		V _R = 1 V		36.8	-	41.8	pF
		V _R = 28 V		2.4	2.6	2.75	pF
C _{d(1V)} /C _{d(28V)}	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		14.5	15	-	

[1] See Figure 2.

[2] See <u>Figure 1</u> and <u>Figure 3</u>.

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7. Package outline

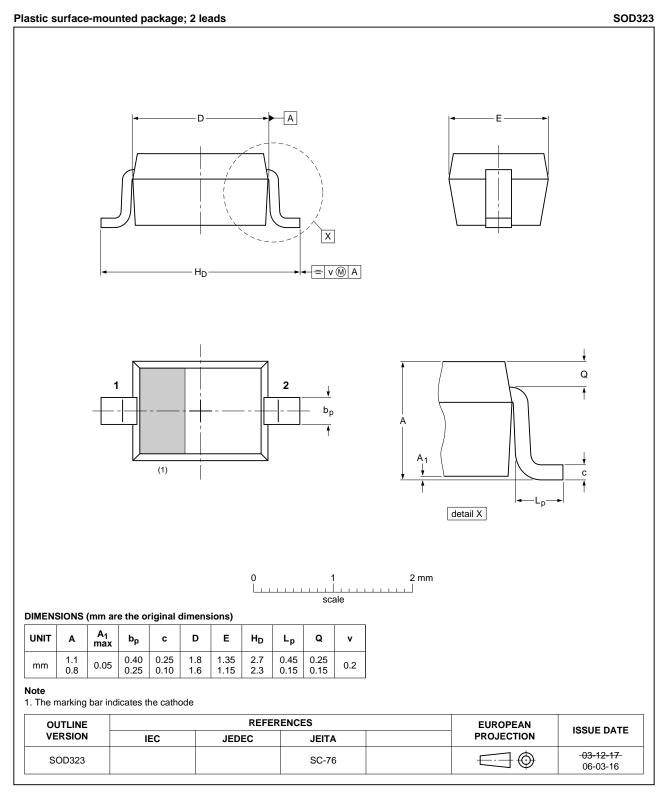


Fig 4. Package outline SOD323 (SC-76)

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8. Abbreviations

Table 6.	Abbreviations
Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision hist	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BB170 v.1	20130325	Product data sheet	-	-	

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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